

## Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

## Features

- ◆ 45V, 15A,  $R_{DS(ON).max}=9m\Omega @ V_{GS}=10V$
- ◆ Improved dv/dt capability
- ◆ Fast switching
- ◆ Green device available

## Applications

- ◆ Motor Drives
- ◆ UPS
- ◆ DC-DC Converter

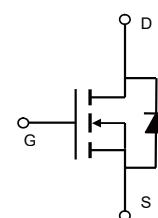
## Product Summary

$V_{DSS}$	45V
$R_{DS(on).max} @ V_{GS}=10V$	9mΩ
$I_D$	15A

## SOP-8 Pin Configuration



SOP-8



Schematic

## Absolute Maximum Ratings

 $T_A = 25^\circ C$  unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	45	V
Continuous drain current ( $T_A = 25^\circ C$ )	$I_D$	15	A
Continuous drain current ( $T_A = 100^\circ C$ )		9.6	A
Pulsed drain current <sup>1)</sup>	$I_{DM}$	60	A
Gate-Source voltage	$V_{GSS}$	$\pm 20$	V
Power Dissipation ( $T_A = 25^\circ C$ )	$P_D$	3.1	W
Storage Temperature Range	$T_{STG}$	-55 to +150	°C
Operating Junction Temperature Range	$T_J$	-55 to +150	°C

## Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	°C/W

## Package Marking and Ordering Information

Device	Device Package	Marking
VSM15N04-S8	SOP-8	VSM15N04-S8

## Electrical Characteristics

 $T_J = 25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static characteristics</b>						
Drain-source breakdown voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0 \text{ V}, I_{\text{D}}=250\mu\text{A}$	45	---	---	V
Gate threshold voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	0.9	1.35	1.8	V
Drain-source leakage current	$I_{\text{DSS}}$	$\text{V}_{\text{DS}}=45 \text{ V}, \text{V}_{\text{GS}}=0 \text{ V}, T_J = 25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$\text{V}_{\text{DS}}=36 \text{ V}, \text{V}_{\text{GS}}=0 \text{ V}, T_J = 125^\circ\text{C}$	---	---	10	$\mu\text{A}$
Gate leakage current, Forward	$I_{\text{GSSF}}$	$\text{V}_{\text{GS}}=20 \text{ V}, \text{V}_{\text{DS}}=0\text{V}$	---	---	100	nA
Gate leakage current, Reverse	$I_{\text{GSSR}}$	$\text{V}_{\text{GS}}=-20 \text{ V}, \text{V}_{\text{DS}}=0\text{V}$	---	---	-100	nA
Drain-source on-state resistance	$R_{\text{DS}(\text{on})}$	$\text{V}_{\text{GS}}=10 \text{ V}, I_{\text{D}}=10\text{A}$	---	6.8	9	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5 \text{ V}, I_{\text{D}}=8\text{A}$	---	8.6	11.5	$\text{m}\Omega$
Forward transconductance	$g_{\text{fs}}$	$\text{V}_{\text{DS}} = 5 \text{ V}, I_{\text{D}}=10\text{A}$	---	36	---	S
<b>Dynamic characteristics</b>						
Input capacitance	$C_{\text{iss}}$	$\text{V}_{\text{DS}} = 25 \text{ V}, \text{V}_{\text{GS}} = 0 \text{ V}, F = 1\text{MHz}$	---	2440	---	pF
Output capacitance	$C_{\text{oss}}$		---	190	---	
Reverse transfer capacitance	$C_{\text{rss}}$		---	126	---	
Turn-on delay time	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}} = 25\text{V}, \text{V}_{\text{GS}}=10\text{V}, I_{\text{D}} = 10\text{A}$	---	14.4	---	ns
Rise time	$t_r$		---	109.8	---	
Turn-off delay time	$t_{\text{d}(\text{off})}$		---	322.2	---	
Fall time	$t_f$		---	90.6	---	
<b>Gate charge characteristics</b>						
Gate to source charge	$Q_{\text{gs}}$	$\text{V}_{\text{DS}}=25\text{V}, I_{\text{D}}=10\text{A}, \text{V}_{\text{GS}}= 10 \text{ V}$	---	8.6	---	nC
Gate to drain charge	$Q_{\text{gd}}$		---	8.2	---	
Gate charge total	$Q_g$		---	49.3	---	
<b>Drain-Source diode characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_s$		---	---	15	A
Pulsed Source Current	$I_{\text{SM}}$		---	---	60	A
Diode Forward Voltage <sup>2)</sup>	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, I_{\text{S}}=10\text{A}, T_J=25^\circ\text{C}$	---	---	1.2	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_{\text{S}}=10\text{A}, \text{di}/\text{dt}=100\text{A}/\text{us}, T_J=25^\circ\text{C}$	---	23.3	---	ns
Reverse Recovery Charge	$Q_{\text{rr}}$		---	14.4	---	nC

Notes:

1: Repetitive Rating: Pulse width limited by maximum junction temperature.

2: Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

## Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

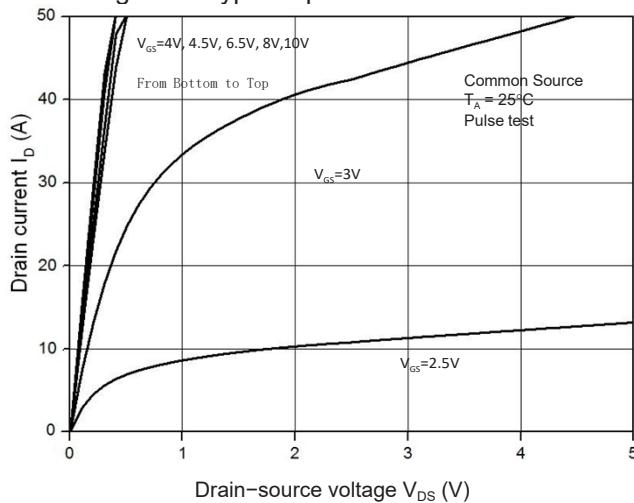


Figure 2. Transfer Characteristics

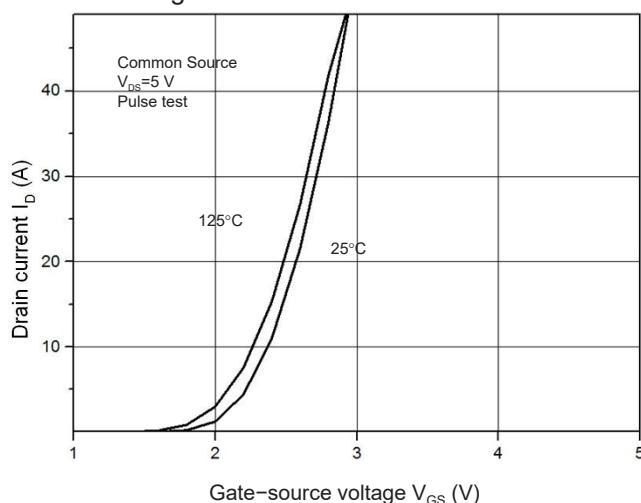


Figure 3. Capacitance Characteristics

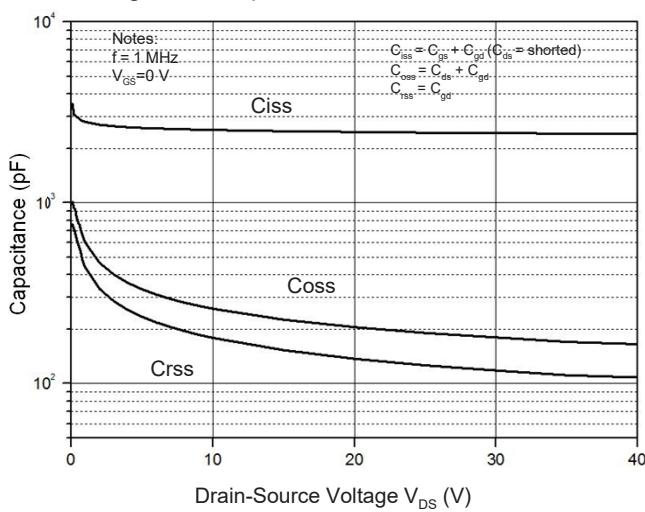


Figure 4. Gate Charge Waveform

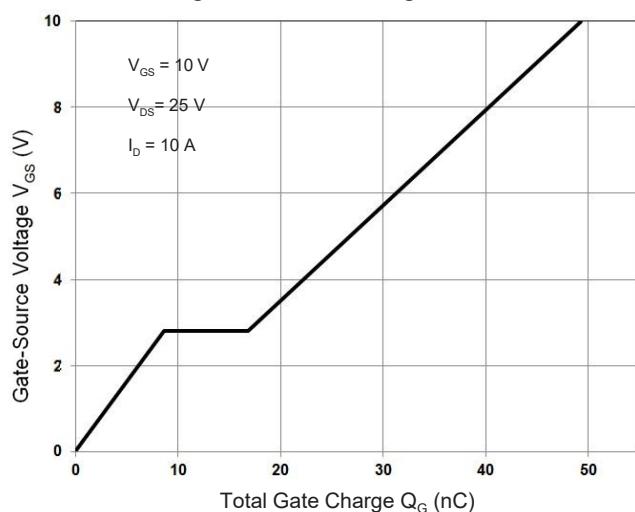


Figure 5. Body-Diode Characteristics

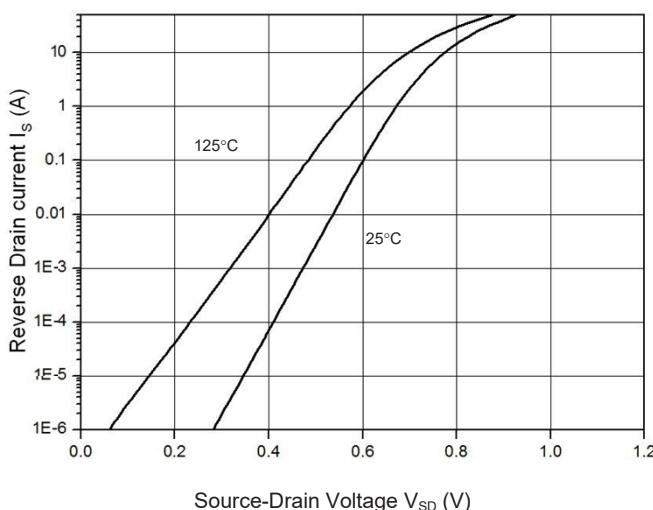


Figure 6. Rdson-Drain Current

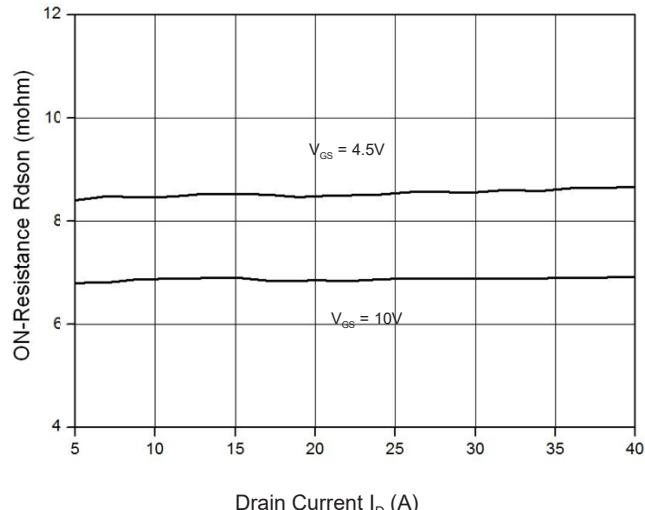


Figure 7. Rdson-Junction Temperature(°C)

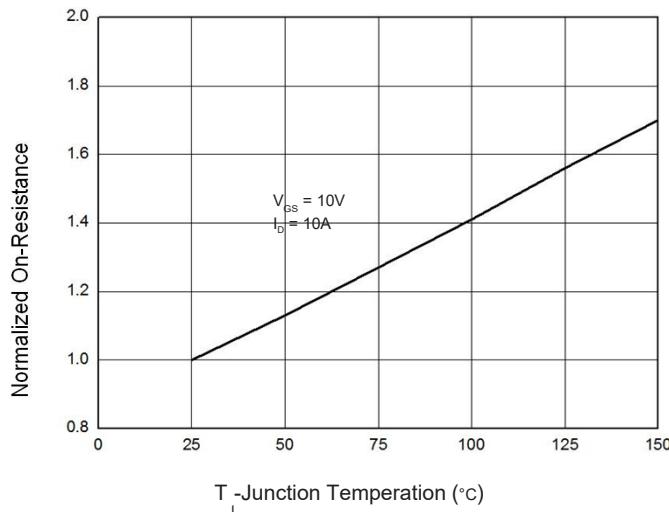


Figure 8. Maximum Safe Operating Area

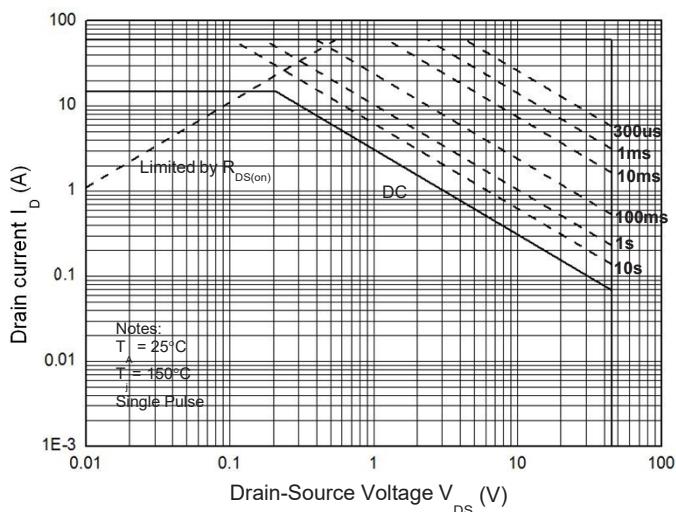
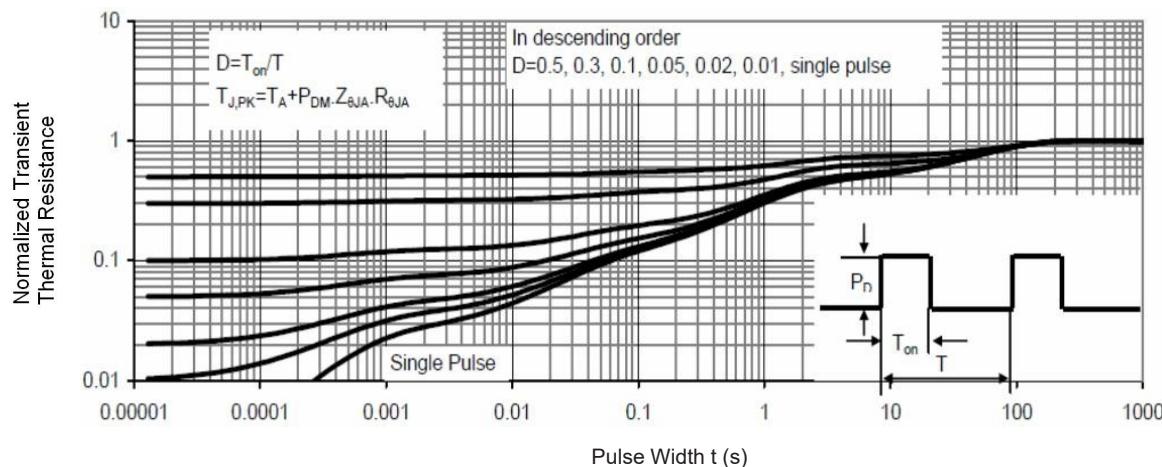


Figure 9. Normalized Maximum Transient Thermal Impedance (RthJA)



## Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform

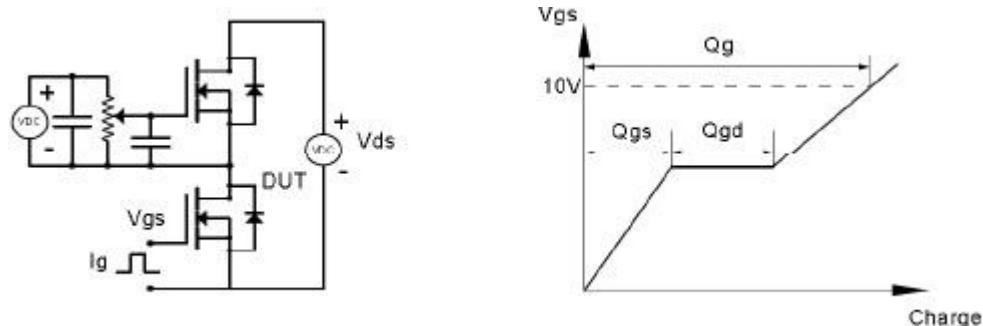


Figure 9. Resistive Switching Test Circuit & Waveforms

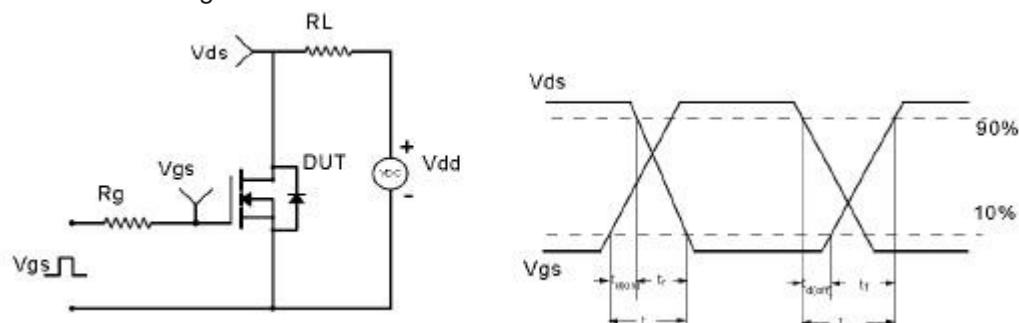


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

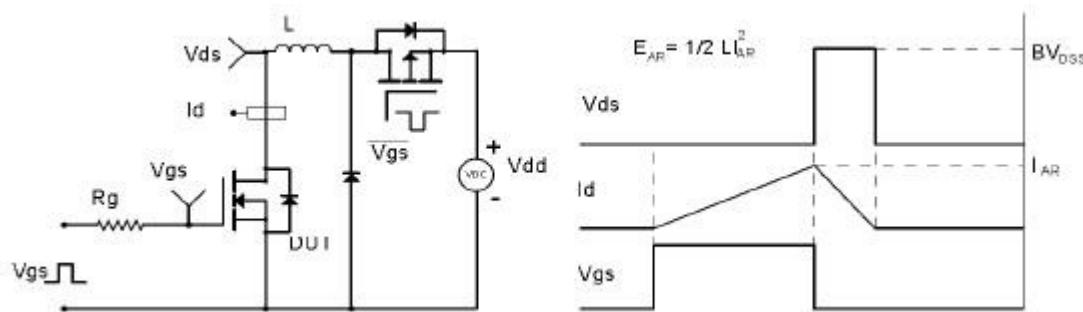


Figure 11. Diode Recovery Circuit & Waveform

